

RF Transformer

ADT1-1WT

75Ω 0.4 to 800 MHz

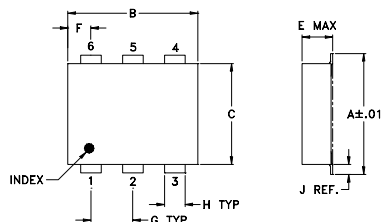
Maximum Ratings

Operating Temperature	-20°C to 85°C
Storage Temperature	-55°C to 100°C
RF Power	0.5W
DC Current	30mA
Permanent damage may occur if any of these limits are exceeded.	

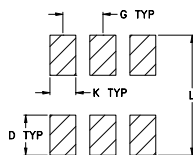
Pin Connections

PRIMARY DOT	3
PRIMARY	1
SECONDARY DOT	6
SECONDARY	4
SECONDARY CT	2
NOT USED	5

Outline Drawing



PCB Land Pattern

Suggested Layout,
Tolerance to be within ±0.002

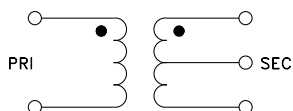
Outline Dimensions (inch/mm)

A	B	C	D	E	F	G
.272	.310	.220	.100	.112	.055	.100
6.91	7.87	5.59	2.54	2.84	1.40	2.54

H	J	K	L	wt
.030	.026	.065	.300	grams
0.76	0.66	1.65	7.62	0.20

Demo Board MCL P/N: TB-430

Config. A



Features

- excellent amplitude unbalance, 0.1 dB typ. and phase unbalance, 1 deg. typ. in 1 dB bandwidth
- aqueous washable
- protected under US patent 6,133,525

Applications

- impedance matching
- balanced amplifier

Generic photo used for illustration purposes only
CASE STYLE: CD542

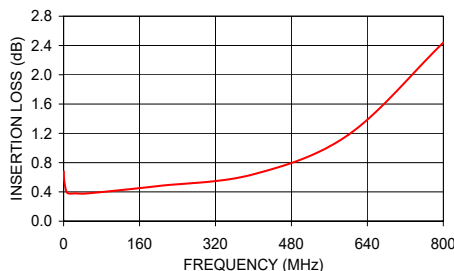
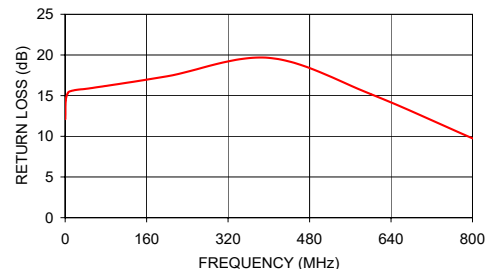
Transformer Electrical Specifications

Ω RATIO	FREQUENCY (MHz)	INSERTION LOSS*			PHASE UNBALANCE (Deg.) Typ.		AMPLITUDE UNBALANCE (dB) Typ.	
		3 dB MHz	2 dB MHz	1 dB MHz	1 dB bandwidth	2 dB bandwidth	1 dB bandwidth	2 dB bandwidth
1	0.4-800	0.4-800	0.5-700	1-400	1	4	0.1	0.5

* Insertion Loss is referenced to mid-band loss, 0.3 dB typ.

Typical Performance Data

FREQUENCY (MHz)	INSERTION LOSS (dB)	INPUT R. LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (Deg.)
0.30	0.68	12.11	0.15	0.25
1.00	0.57	14.38	0.07	0.36
5.00	0.42	15.29	0.03	0.41
10.00	0.38	15.54	0.00	0.40
25.00	0.38	15.73	0.02	0.37
50.00	0.38	15.91	0.03	0.49
200.00	0.48	17.38	0.03	1.48
400.00	0.64	19.64	0.26	2.02
600.00	1.18	15.20	0.79	1.45
800.00	2.44	9.75	1.72	0.40

ADT1-1WT
INSERTION LOSSADT1-1WT
INPUT RETURN LOSS

Notes

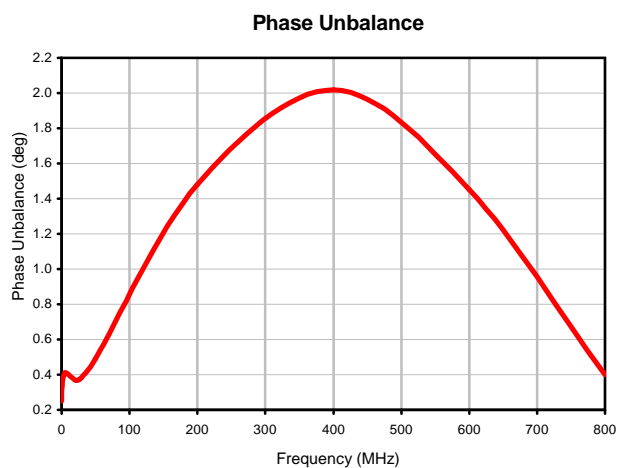
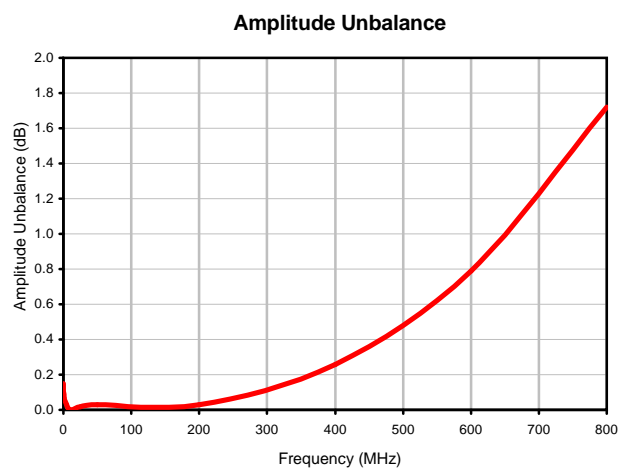
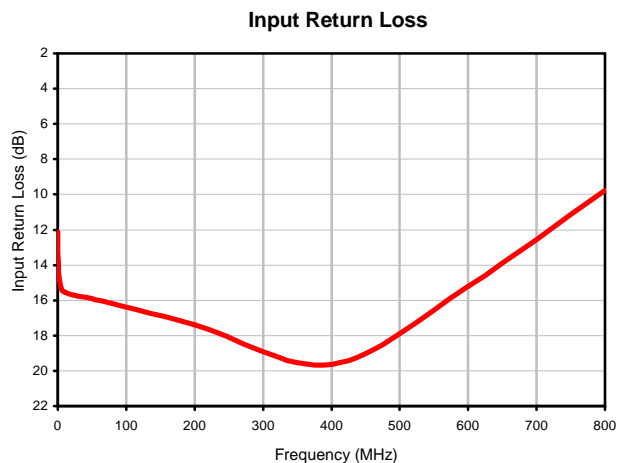
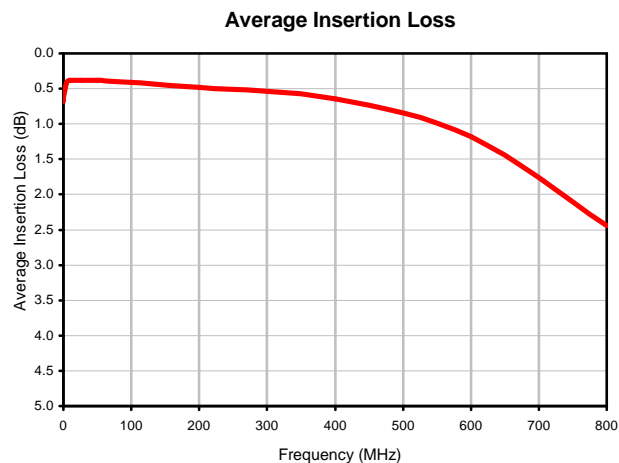
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B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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Typical Performance Data

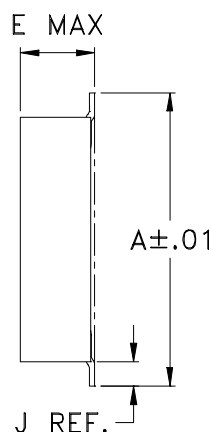
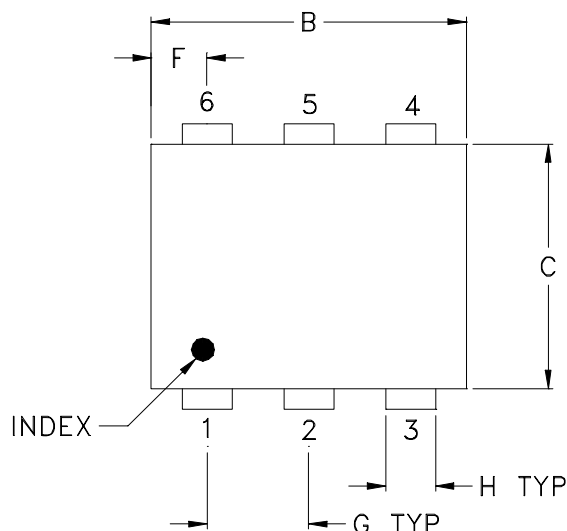
FREQUENCY (MHz)	AVERAGE INSERTION LOSS (dB)	INPUT RETURN LOSS (dB)	AMPLITUDE UNBALANCE (dB)	PHASE UNBALANCE (deg)
0.3	0.68	12.11	0.15	0.25
1.0	0.57	14.38	0.07	0.36
5.0	0.42	15.29	0.03	0.41
10.0	0.38	15.54	0.00	0.40
25.0	0.38	15.73	0.02	0.37
50.0	0.38	15.91	0.03	0.49
200.0	0.48	17.38	0.03	1.48
400.0	0.64	19.64	0.26	2.02
600.0	1.18	15.20	0.79	1.45
800.0	2.44	9.75	1.72	0.40

Typical Performance Curves

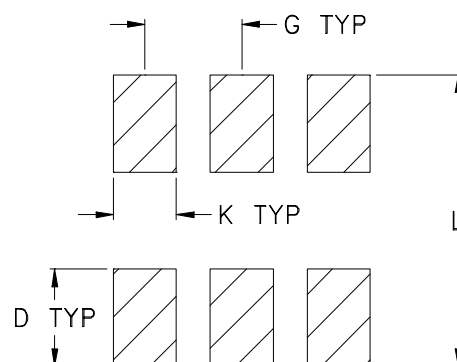


CD541
CD542
CD636
CD637

Outline Dimensions



PCB Land Pattern



Suggested Layout,
Tolerance to be within $\pm .002$

CASE#	A	B	C	D	E	F	G	H	J	K	L	WT, GRAM
CD541					.082 (2.08)							.15
CD542	.272 (6.91)	.310 (7.87)	.220 (5.58)	.100 (2.54)	.112 (2.84)	.055 (1.40)	.100 (2.54)	.030 (0.76)	.026 (0.66)	.065 (1.65)	.300 (7.62)	.20
CD636					.162 (4.11)							.25
CD637					.206 (5.23)							.40

Dimensions are in inches (mm). Tolerances: 2 Pl. $\pm .01$; 3 Pl. $\pm .005$

Notes:

- Case material: Plastic.
- Termination finish:
For RoHS Case Styles: Tin plate over Nickel plate. All models, (+) suffix.
For RoHS-5 Case Styles: Tin-Lead plate. All models, no (+) suffix.



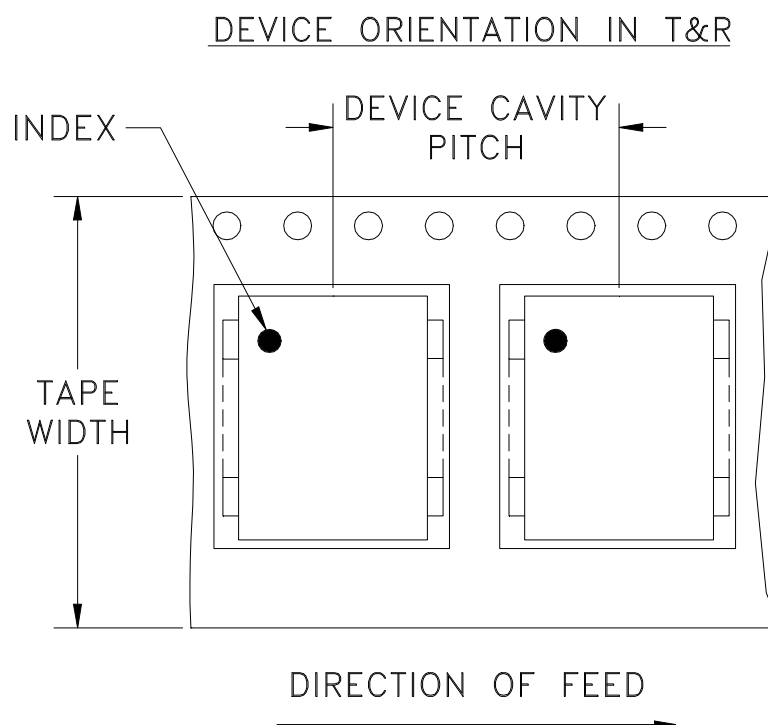
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Tape & Reel Packaging TR-F34



Tape Width, mm	Device Cavity Pitch, mm	Reel Size, inches	Devices per Reel see note	
16	12	7	Small quantity standard (see note)	20
				50
				100
				200
		13	Standard	500
				1000

Note: Availability of small reel quantity varies by model.
Refer to pricing and availability on individual model dashboard.

Mini-Circuits carrier tape materials provide protection from ESD (Electro-Static Discharge) during handling and transportation. Tapes are static dissipative and comply with industry standards EIA-481/EIA-541.

Go to: www.minicircuits.com/pages/pdfs/tape.pdf



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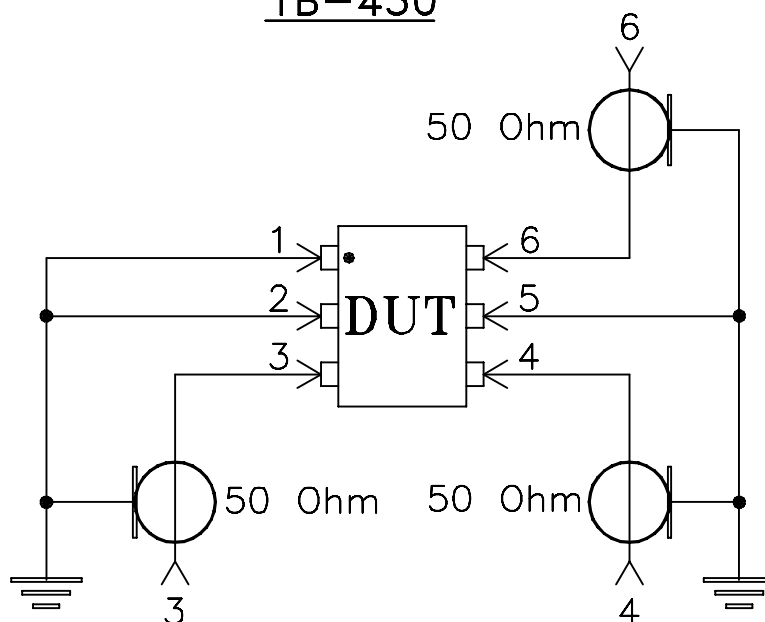
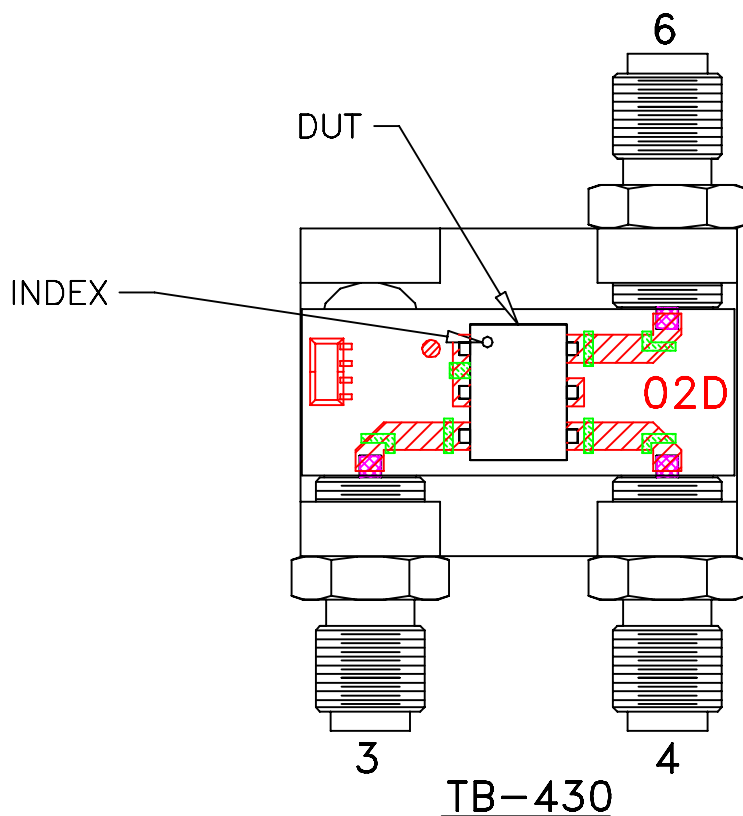
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Evaluation Board and Circuit


For Pin Connections refer to Data Sheet of the DUT



Schematic Diagram

Notes:

1. SMA Female connectors.
2. PCB Material: Rogers R04350 or equivalent, Dielectric Constant=3.5, Thickness=.030 inch.
3. Must use ENA/PNA type agilent's network analyzers with impedance conversion option to convert ports to appropriate impedances.

 Mini-Circuits®



All Mini-Circuits products are manufactured under exacting quality assurance and control standards, and are capable of meeting published specifications after being subjected to any or all of the following physical and environmental test.

Specification	Test/Inspection Condition	Reference/Spec
Operating Temperature	-20° to 85°C Ambient Environment	Individual Model Data Sheet
Storage Temperature	-55° to 100° C Ambient Environment	Individual Model Data Sheet
Humidity	90 to 95% RH, 240 hours, 50°C	MIL-STD-202, Method 103, Condition A, Except 50°C and end-point electrical test done within 12 hours
Thermal Shock	-55° to 100°C, 100 cycles	MIL-STD-202, Method 107, Condition A-3, except +100°C
Solder Reflow Heat	Sn-Pb Eutetic Process: 225°C peak Pb-Free Process 245° - 250°C peak	J-STD-020, Table 4-1, 4-2 and 5-2, Figure 5-1
Solderability	10X Magnification	J-STD-002, 95% Coverage
Vibration (High Frequency)	20g peak, 10-2000 Hz, 12 times in each of three perpendicular directions (total 36)	MIL-STD-202, Method 204, Condition D
Mechanical Shock	50g, 11 ms, 1/2-sine, 18 shocks: 3 each direction, each of 3 axes	MIL-STD-202, Method 213, Condition A
Marking Resistance to Solvents	Isopropyl alcohol + mineral spirits at 25°C; terpene defluxer at 25°C; distilled water + proylene glycol monomethyl ether + monoethanolamine at 63°C to 70°C	MIL-STD-202, Method 215